

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	1	("20020039464").PN.	US-PGPUB; USPAT	OR	OFF	2005/04/26 09:40
L2	0	L1 and (plastic with fiber)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/26 09:40
L3	1	L1 and (plastic fiber)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/26 09:40
L4	1	L1 and (plastic)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/26 09:40
L5	0	L1 and (plastic with waveguide)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/26 09:40
L6	7327	385/14,24.ccls. 398/141.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/26 09:45
L7	46	L6 and (((array\$4 pluralit\$3) with (PD photo adj3 detector diode emitter trasmit\$4 receiv\$4 laser transceiv\$4) with substrate) same (waveguide fiber fibre)) with (mux dmx multiplex\$4 demultiplex\$4 filter WDM grating))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/26 09:48
L8	641	385/901.ccls.	US-PGPUB; USPAT	OR	ON	2005/04/26 15:08
L9	11	l8 and (((array\$4 pluralit\$3) with (PD photo adj3 detector diode emitter trasmit\$4 receiv\$4 laser transceiv\$4) with substrate) same (waveguide fiber fibre))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/26 10:27

L10	176	I8 and (IC adj3 chip\$1 chip, circuitry, computer adj3 chip\$1, IC, logic adj3 circuit, microchip, microcircuit, microelectronics, microprocessor, microprocessor chip, semiconductor chip, silicon chip, transputer integrated adj3 circuit)	US-PGPUB; USPAT	OR	ON	2005/04/26 15:08
L11	10	I9 and (IC adj3 chip\$1 chip, circuitry, computer adj3 chip\$1, IC, logic adj3 circuit, microchip, microcircuit, microelectronics, microprocessor, microprocessor chip, semiconductor chip, silicon chip, transputer integrated adj3 circuit)	US-PGPUB; USPAT	OR	ON	2005/04/26 10:34
L18	1	("20030025962").PN.	US-PGPUB; USPAT	OR	OFF	2005/04/26 13:20
L19	1	I18 and (wir\$3)	US-PGPUB; USPAT	OR	ON	2005/04/26 13:20
L20	2	I8 and (timing with (IC adj3 chip\$1 chip, circuitry, computer adj3 chip\$1, IC, logic adj3 circuit, microchip, microcircuit, microelectronics, microprocessor, microprocessor chip, semiconductor chip, silicon chip, transputer integrated adj3 circuit))	US-PGPUB; USPAT	OR	ON	2005/04/26 16:07
L21	3	I10 and ((plastice resin) near6( waveguide))	US-PGPUB; USPAT	OR	ON	2005/04/26 16:09
L22	103	385/14.ccls. and ((plastice resin) near6( waveguide))	US-PGPUB; USPAT	OR	ON	2005/04/26 16:08
L23	6	385/14.ccls. and ((plastice resin) near6( waveguide)) and display	US-PGPUB; USPAT	OR	ON	2005/04/26 16:09
L24	1125	385/129.ccls. and @ad<"20021206"	US-PGPUB; USPAT	OR	ON	2005/04/26 16:09
L25	53	I24 and ((plastice resin) near6( waveguide))	US-PGPUB; USPAT	OR	ON	2005/04/26 16:10
S2	9051	385/49,901,24,47,39,48,88.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/25 09:57
S3	18	S2 and (tile with substrate)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/25 09:41

S4	9051	385/49,901,24,47,39,48,88.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/25 13:03
S5	0	S4 and (tile adj3 micro with substrate)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/25 09:41
S6	17	385/14.ccls. and (tile with substrate)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/25 10:11
S7	21	"385"/\$.ccls. and (tile with substrate with (trasmit\$5 receiv\$4 transceiv\$4 source))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/25 10:12
S8	5	(US-20040228579-\$).did. or (US-6845184-\$ or US-6167169-\$ or US-5664032-\$ or US-5369719-\$). did.	US-PGPUB; USPAT	OR	ON	2005/04/25 11:37
S9	5	S8 and tile	US-PGPUB; USPAT	OR	ON	2005/04/25 11:37
S10	22	385/14,49,901,24,47,39,48,88.ccls. and (waveguide with tile)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/25 13:09
S11	3	385/14,49,901,24,47,39,48,88.ccls. and ((waveguide with tile) same multiplex\$4)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/25 13:12
S12	4	"385"/\$.ccls. and ((waveguide with tile) same multiplex\$4)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/25 13:13

S13	4	"385"/\$.ccls. and ((waveguide same tile) same multiplex\$4)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/25 14:27
S14	7320	385/14,24.ccls. 398/141.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/25 14:28
S15	197	S14 and (array\$4 with (PD photo adj3 detector diode emitter trasmit\$4 receiv\$4 laser transceiv\$4) with substrate)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/25 14:29
S16	222	S14 and (((array\$4 pluralit\$3) with (PD photo adj3 detector diode emitter trasmit\$4 receiv\$4 laser transceiv\$4) with substrate) same (waveguide fiber fibre))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/26 10:26
S17	196	S16 and @ad<"20021206"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/25 14:43
S18	0	S17 and tiel	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/25 14:41
S19	9	S17 and tile	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/25 14:41
S20	143	S17 and (mux dmux multiplex\$4 demultiplex\$4 filter WDM grating)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/26 09:43

S21	64662	kondo.in.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/25 16:21
S22	64678	kondo.in. "722,441"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/25 16:21
S23	1	kondo.in. and "722,441"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/25 16:21
S24	1	("20020039464").PN.	US-PGPUB; USPAT	OR	OFF	2005/04/25 16:32
S25	1	S24 and (wavelength)	US-PGPUB; USPAT	OR	ON	2005/04/25 16:35
S26	0	S24 and (wavelength with ("28" "36" "26"))	US-PGPUB; USPAT	OR	ON	2005/04/25 16:36
S27	0	S24 and (wavelength with ("28"))	US-PGPUB; USPAT	OR	ON	2005/04/25 16:36
S28	0	S24 and (wavelength with (28\$1))	US-PGPUB; USPAT	OR	ON	2005/04/25 16:36
S29	0	S24 and (wavelength with ("28"\$1))	US-PGPUB; USPAT	OR	ON	2005/04/25 16:36
S30	0	S24 and (wavelength with 1a)	US-PGPUB; USPAT	OR	ON	2005/04/25 16:37